IPC - ASSOCIATION CONNECTING ELECTRONICS INDUSTRIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfc Information			
upplier Inforn	nation								,					
Company name*			Company unique ID			τ	Unique ID Authority				Response Date*			
nsemi											2023-06-08			
Contact Name		Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-Env-Stewa	ards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorized Represe	entative*	Title - Representative			P	Phone - Representative*			Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
Request	er Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	M	Manufacturing Site		Weight*	UOM	Unit Type
	FOD8160 SSO5		SSO5 3.3V 10MB			2023-06-08		Pl	PBB		197.151	mg	Each	
	Process Informati			A11	CTD 020 MCI	D - 4	Deeds Door	Do do To		Mary Time at Deale	T	NI	and Darkers Court	1
			Terminal Base Alloy J-STD-020 MSL		Kating	Peak Process Body Temperatus		•				er of Reflow Cyc	cies	
	n (Sn) - annealed	C	U Alloy	1			260		C	30	secon	ds   3		
omments														
	time at peak temperatur													
or more informati	on regarding material co	omposition p	please refer to	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	ogeneous Material Weight Unit of Measure Level Substance		Substance	CAS	Exempt	Weight	Unit of Measure	
Coupling Gel	3.5	mg	Supplier	Dimethyl Siloxane	68083-19-2		3.5	mg
Die	1.131	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.071	mg
			Supplier	Silicon (Si)	7440-21-3		1.06	mg
Die Attach	0.223	mg	Supplier	Silver (Ag)	7440-22-4		0.1784	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0446	mg
Lead Frame	36.392	mg	Supplier	Silver (Ag)	7440-22-4		0.2	mg
			Supplier	Zinc (Zn)	7440-66-6		0.044	mg
			Supplier	Iron (Fe)	7439-89-6		0.837	mg
			Supplier	Copper (Cu)	7440-50-8		35.3	mg
			Supplier	Phosphorus (P)	7723-14-0		0.011	mg
Mold Compound-Black	153.98	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		30.8	mg
			Supplier	2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		6.16	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		35.4	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		4.62	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		77	mg
Plating	1.69	mg	Supplier	Tin (Sn)	7440-31-5		1.69	mg
Wire Bond - Au	0.235	mg	Supplier	Gold (Au)	7440-57-5		0.235	mg